

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	MULTI-RUN SELECTIVE PATTERN AND ETCH WAFER PROCESS
--------------------	--

Application Number:

Confirmation Number:

First Named Applicant: Kenneth Bandy

Attorney Docket Number: BUR920020075US1

Search string: (6245581 or 6232134 or 5980766 or 5790254 or 5629772).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
LV	1	6245581	2001-06-12	Bonser et al.		438	8
LW	2	6232134	2001-05-15	Farber et al.		438	9
LV	3	5980766	1999-11-09	Flamm et all.		216	59
LV	4	5790254	1998-08-04	Ausschnitt		356	372
LV	5	5629772	1997-05-13	Ausschnitt		256	372

Signature

Examiner Name	Date
LAN VINH	2/14/05